

# PRODUCT / PROCESS CHANGE NOTIFICATION

## 1. PCN basic data

|                      |                                                                                                                        |
|----------------------|------------------------------------------------------------------------------------------------------------------------|
| 1.1 Company          |  STMicroelectronics International N.V |
| 1.2 PCN No.          | POWER AND DISCRETE PRODUCTS/24/14727                                                                                   |
| 1.3 Title of PCN     | VIpower® products in TO220: Activation of TONGKE Back-End Plant                                                        |
| 1.4 Product Category | see list                                                                                                               |
| 1.5 Issue date       | 2024-05-20                                                                                                             |

## 2. PCN Team

|                           |                         |
|---------------------------|-------------------------|
| 2.1 Contact supplier      |                         |
| 2.1.1 Name                | KRISZTINA NEMETH        |
| 2.1.2 Phone               | +49 89460062210         |
| 2.1.3 Email               | krisztina.nemeth@st.com |
| 2.2 Change responsibility |                         |
| 2.2.1 Product Manager     | Rosario RUGGERI         |
| 2.1.2 Marketing Manager   | Carmelo PISTRITTO       |
| 2.1.3 Quality Manager     | Daniela FAZIO           |

## 3. Change

|              |                                                                                                                                                 |                                         |
|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|
| 3.1 Category | 3.2 Type of change                                                                                                                              | 3.3 Manufacturing Location              |
| Transfer     | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617) | Subcon TONGKE - China - Receiving Plant |

## 4. Description of change

|                                                                                       |                                          |                                            |
|---------------------------------------------------------------------------------------|------------------------------------------|--------------------------------------------|
|                                                                                       | Old                                      | New                                        |
| 4.1 Description                                                                       | ST Shenzhen Assy and Final Test Location | Subcon TONGKE Assy and Final Test Location |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact                                |                                            |

## 5. Reason / motivation for change

|                      |                    |
|----------------------|--------------------|
| 5.1 Motivation       | Service Continuity |
| 5.2 Customer Benefit | SERVICE CONTINUITY |

## 6. Marking of parts / traceability of change

|                 |                               |
|-----------------|-------------------------------|
| 6.1 Description | Dedicated Finished Good Codes |
|-----------------|-------------------------------|

## 7. Timing / schedule

|                                     |              |
|-------------------------------------|--------------|
| 7.1 Date of qualification results   | 2024-04-22   |
| 7.2 Intended start of delivery      | 2024-07-01   |
| 7.3 Qualification sample available? | Upon Request |

## 8. Qualification / Validation

|                                                    |                                                                                       |            |            |
|----------------------------------------------------|---------------------------------------------------------------------------------------|------------|------------|
| 8.1 Description                                    | 14727 RERLVIP24013_1.0_VIPower M02 and M03_TO220 transfer from STS to TFME Tongke.pdf |            |            |
| 8.2 Qualification report and qualification results | Available (see attachment)                                                            | Issue Date | 2024-05-20 |

## 9. Attachments (additional documentations)

14727 Public product.pdf  
 14727 Details.pdf  
 14727 RERLVIP24013\_1.0\_VIPower M02 and M03\_TO220 transfer from STS to TFME Tongke.pdf

| 10. Affected parts      |                         |                          |
|-------------------------|-------------------------|--------------------------|
| 10. 1 Current           |                         | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No  |
|                         | VNP10N07-E              |                          |
|                         | VNP20N07-E              |                          |
|                         | VNP35N07-E              |                          |

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